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CM1682

2 Channel EMI Filter with ESD Protection for Headsets/Speakers

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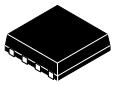


CUDFN8
DE SUFFIX
CASE 505AF

Features

- Two Channels of EMI Filtering
- Pi−Style EMI Filters in a Capacitor−Resistor−Capacitor (C−R−C) Network
- ±8 kV ESD Protection (IEC 61000−4−2, Contact Discharge)
- ±15 kV ESD Protection (HBM)
- Supports AC Signals − Ideal for Audio Applications
- Greater than 40 dB of Attenuation at 1 GHz
- 8−Lead, 2.00 mm x 2.00 mm Footprint CUDFN Package
- Low Profile Height of 0.5 mm
- These Devices are Pb−Free and are RoHS Compliant

Applications

- Headset Microphone Port in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers

MARKING DIAGRAM

P82 = CM1682−02DE

ORDERING INFORMATION

Device	Package	Shipping†
CM1682−02DE	CUDFN−8 (Pb−Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL SCHEMATIC

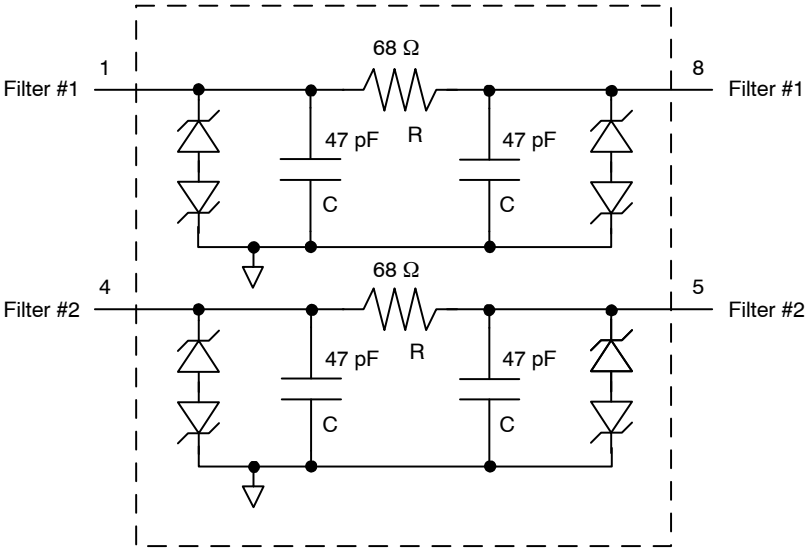
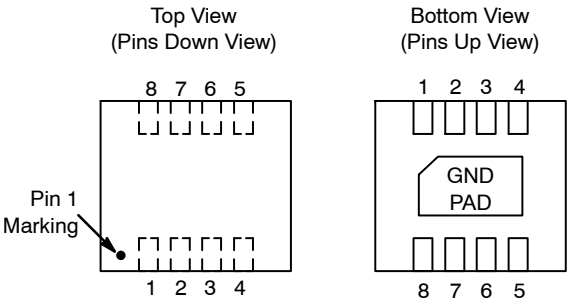


Table 1. PIN DESCRIPTIONS

8−Lead CUDFN Package		
Pin	**Name**	**Description**
1	Filter #1	Filter #1
2	NC	No connect
3	NC	No connect
4	Filter #2	Filter #2
5	Filter #2	Filter #2
6	NC	No connect
7	NC	No connect
8	Filter #1	Filter #1
GND PAD	GND	Ground

PACKAGE / PINOUT DIAGRAMS



8−Lead CUDFN Package

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	−65 to +150	°C
DC package power rating	0.5	W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	−40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R	Resistance R		61	68	75	Ω
R_{MATCH}	Resistor−to−Resistor Matching	(Note 3)			5	%
C_{TOT}	Total Channel Capacitance	2.5 V DC; 1 MHz, 30 mV AC	74	94	114	pF
C	Capacitance C			47		pF
I_{LEAK}	Diode Leakage Current	V_{IN} = ±5.0 V		0.1	1.0	μA
V_{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	 I_{LOAD} = 10 mA I_{LOAD} = −10 mA	 5 −15	 7 −10	 15 −5	V
V_{ESD}	In−system ESD Withstand Voltage: a) Human Body Model, MIL−STD−883, Method 3015 b) Contact Discharge per IEC 61000−4−2 Level 4	(Note 2)	 ±15 ±8			kV
f_C	Cut−off frequency Z_{SOURCE} = 50 Ω, Z_{LOAD} = 50 Ω	R = 68 Ω, C = 47 pF		60		MHz

1. T_A = 25°C unless otherwise specified.
2. ESD applied to input and output pins with respect to GND, one at a time. Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin (i.e. if ESD is applied to pin 1 then clamping voltage is measured at pin 8).

PERFORMANCE INFORMATION

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)

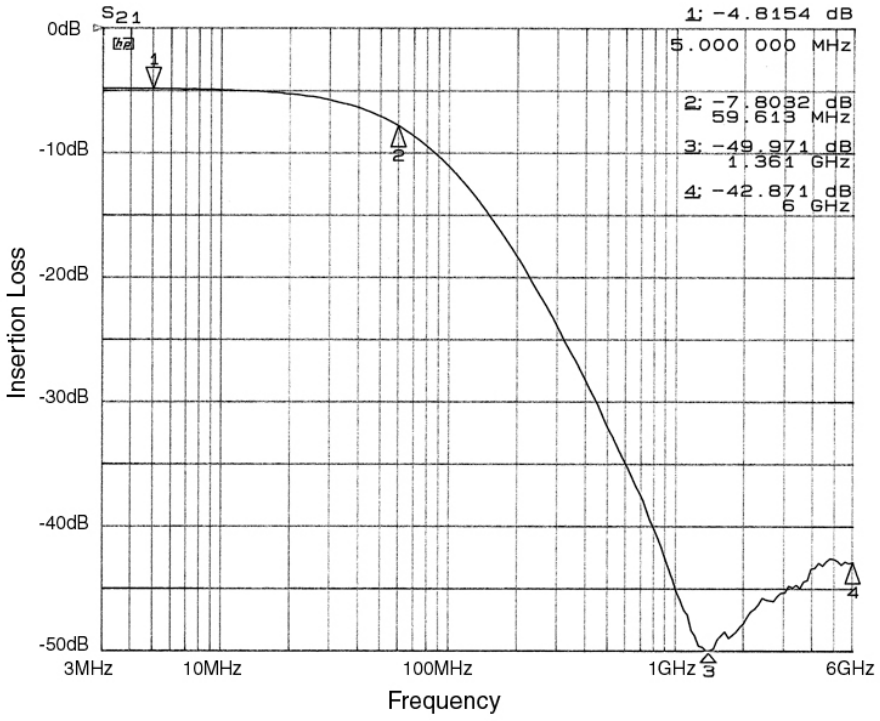


Figure 1. Insertion Loss vs. Frequency (Filter #1 to GND)

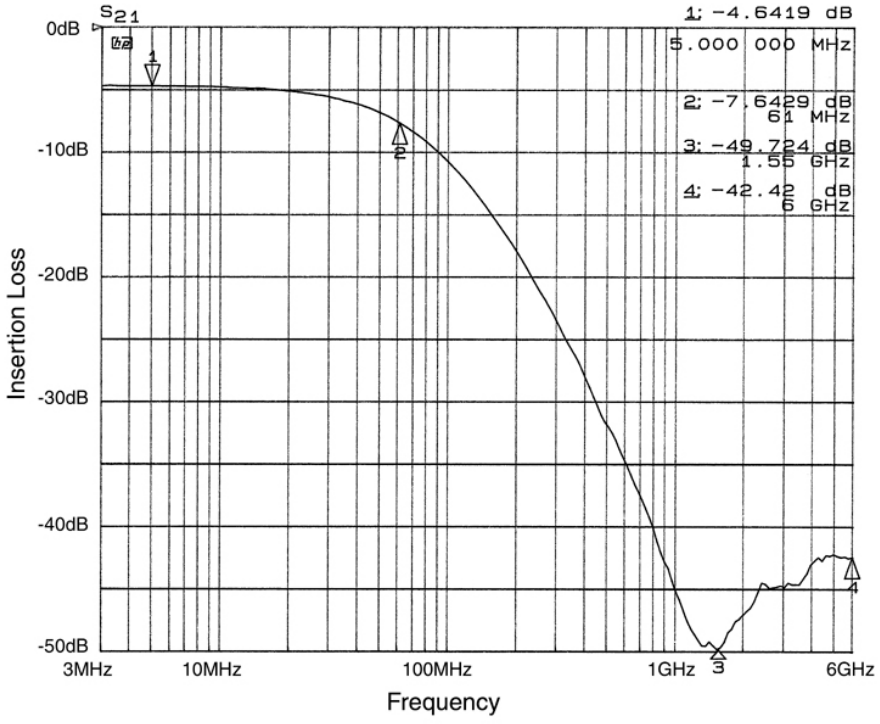
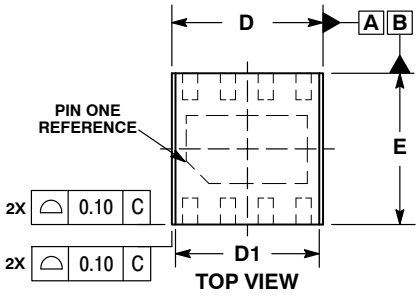
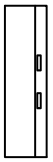


Figure 2. Insertion Loss vs. Frequency (Filter #2 to GND)

PACKAGE DIMENSIONS

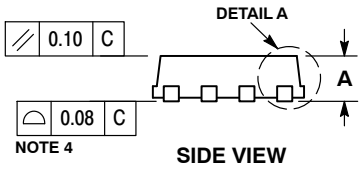
CUDFN8, 2x2, 0.5P
CASE 505AF−01
ISSUE O

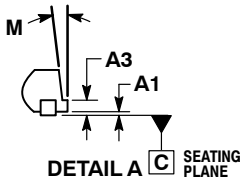


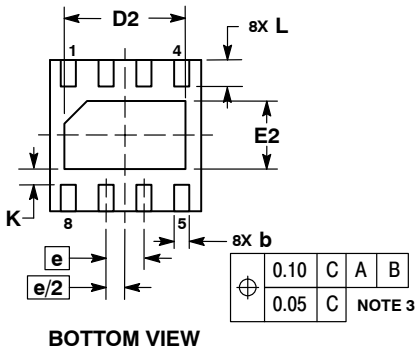


NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.10 AND 0.20mm FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

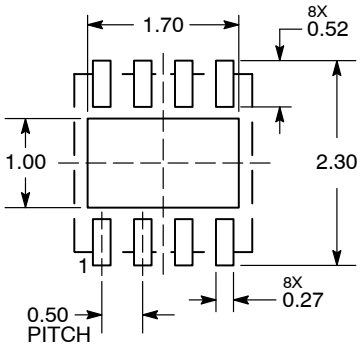
	MILLIMETERS	
DIM	MIN	MAX
A	0.55	0.65
A1	0.00	0.05
A3	0.20 REF	
b	0.15	0.25
D	2.00 BSC	
D1	1.80 BSC	
D2	1.50	1.70
E	2.00 BSC	
E2	0.80	1.00
e	0.50 BSC	
K	0.20	---
L	0.25	0.35
M	---	10°







RECOMMENDED MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
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